

LOW VOLTAGE, FULL DUPLEX CVSD CODEC WITH SERIAL CONTROL

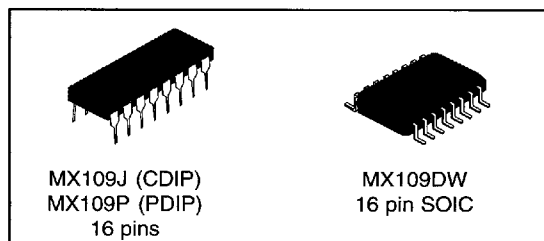
FEATURES

- Single Chip Full Duplex CVSD CODEC
- On-chip Input & Output Filters
- On-chip Volume Control
- 3V Operating Voltage
- Wide Frequency Reference using Ceramic Oscillator
- Low Power, Single Supply Analog CMOS

- Digital Voice Storage
- Multiplexers, Switches & Phones
- Time Domain Scramblers
- Rechargeable Cell Operation

APPLICATIONS

- Digital Cordless Phones
- Digital PCN/PCS Systems
- Digital Delay Lines



Description

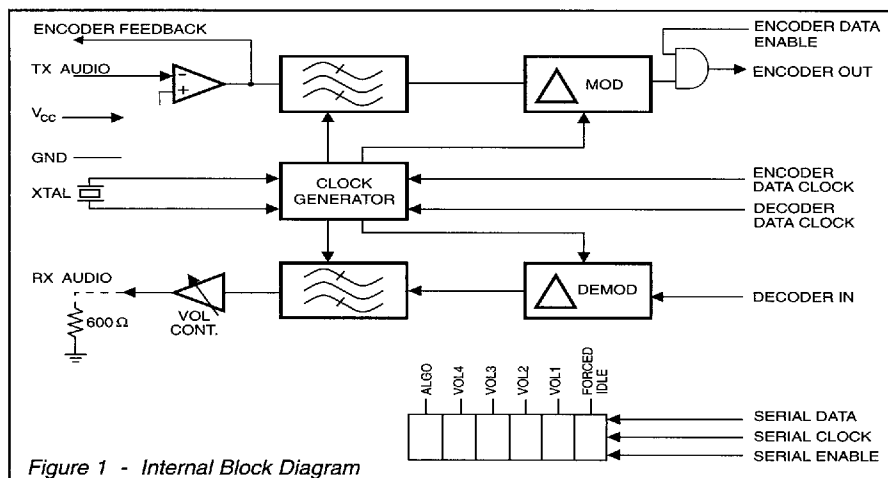
The MX109 is a Continuously Variable Slope Delta Modulation (CVSD) Codec designed for use in cordless telephones. The device is suitable for applications in delta multiplexers, switches and phones. Encoder input and decoder output switched capacitor filters are incorporated on-chip.

Sampling clock rates can be externally injected in the 8 to 64K bits/second range. The internal clocks are derived from an on-chip reference oscillator driven by

an externally connected crystal or ceramic resonator. The sampling clock frequency is output for the synchronization of external circuits.

The encoder has an enable function for use in multiplexer applications. When not enabled the encoder output remains in a high-impedance "tri-state" mode.

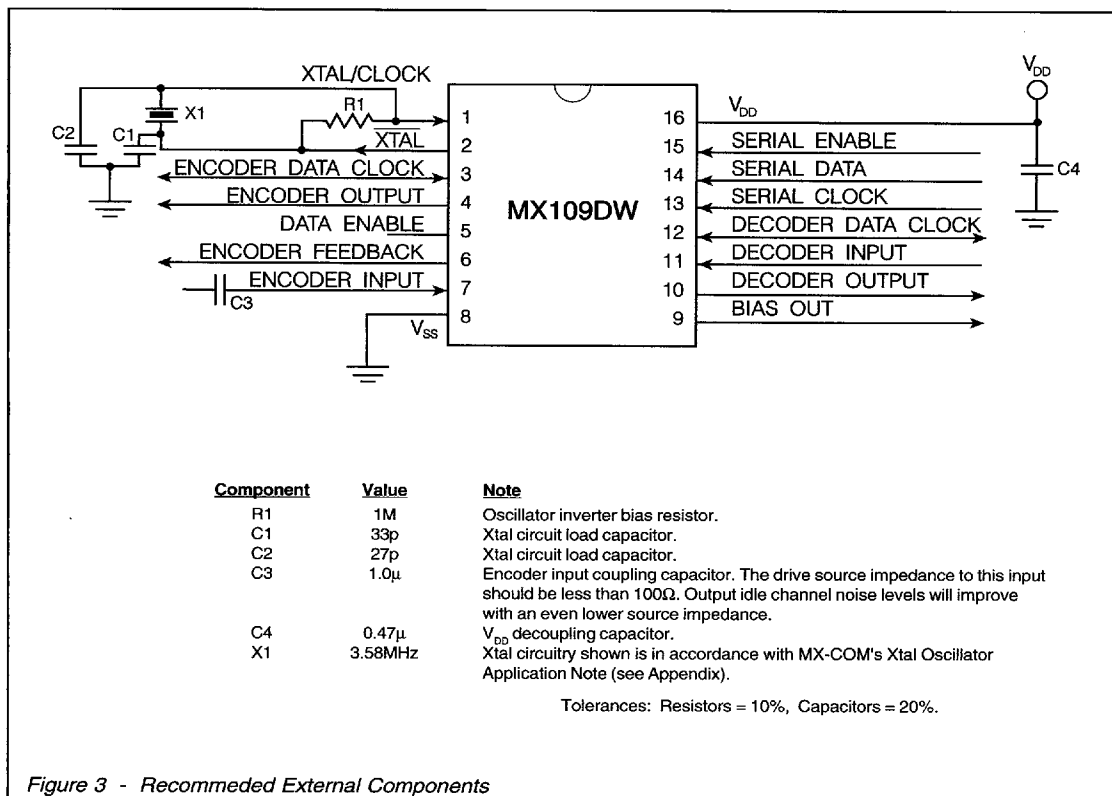
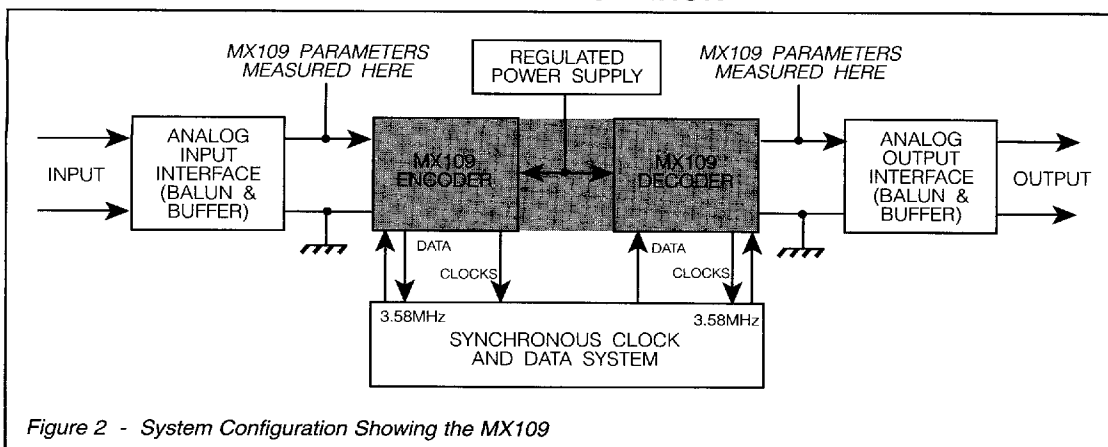
The MX109 is a low-power CMOS device. It is available in PDIP, CDIP and SOIC packages.



PIN FUNCTION CHART

Pin	Function
1	Xtal/Clock (I/P): Input to the clock oscillator inverter. A 3.58 MHz Xtal input or externally derived clock is injected here. See Figure 3.
2	Xtal (O/P): The 3.58 MHz output of the clock oscillator inverter.
3	Encoder Data Clock: A logic I/O port. External encode clock input.
4	Encoder Output: The encoder digital output.
5	Data Enable: Data is made available at the encoder output pin by control of this input. Internal 1 M Ω pullup.
6	Encoder Feedback: The output of the encoder input amplifier / the input to the encoder filter.
7	Encoder Input: The analog signal input. Internally biased at $V_{DD}/2$, this input requires an external coupling capacitor. The source impedance should be less than 100 Ω . Output channel noise levels will improve with an even lower source impedance. See Figure 3.
8	V_{SS}: Negative Supply
9	Bias Out: Normally at $V_{DD}/2$ bias.
10	Decoder Output: The recovered analog signal is output at this pin. It is the buffered output of a bandpass filter and requires external components.
11	Decoder Input: The received digital signal input. Internal 1 M Ω pullup.
12	Decoder Data Clock: A logic I/O port. External decode clock input.
13	Serial Clock: This is the serial clock input.
14	Serial Data: This is the serial data input. Data is loaded in the following order: ALGO, VOL4, VOL3, VOL2, VOL1, FORCE IDLE.
15	Serial I/O Enable: A logic 1 applied to this input will enable serial programming.
16	V_{DD}: Positive Supply.

CODEC INTEGRATION



CODEC TIMING INFORMATION

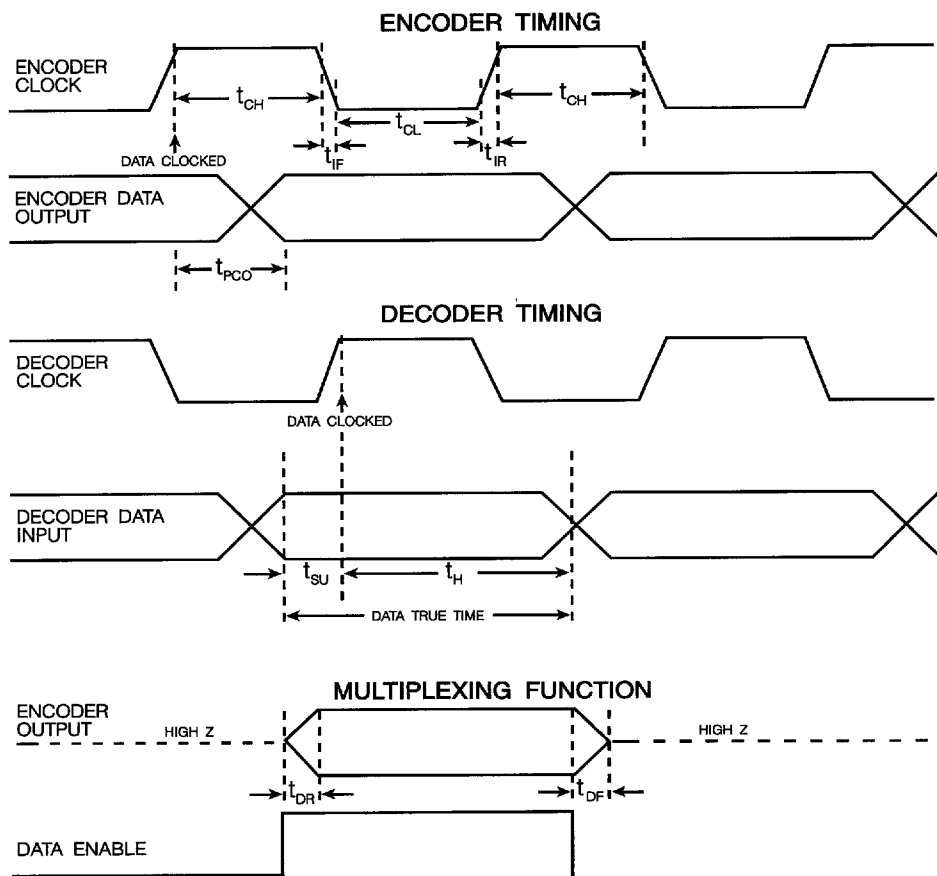


Figure 4 - Codec Timing

Abbreviation	Description	Time
t_{CH}	Clock pulse width (logic 1)	1.0 μ s min.
t_{CL}	Clock pulse width (logic 0)	1.0 μ s min.
t_{IR}	Clock rise time	100ns typ.
t_{IF}	Clock fall time	100ns typ.
t_{SU}	Data set-up time	450ns max.
t_H	Data hold time	600ns min.
$t_{SU} + t_H$	Data true time	1.5 μ s typ.
t_{PCO}	Clock to output delay time	750ns typ.
t_{DR}	Data rise time	100ns typ.
t_{DF}	Data fall time	100ns typ.
	Xtal input frequency	3.58MHz

CODEC PERFORMANCE

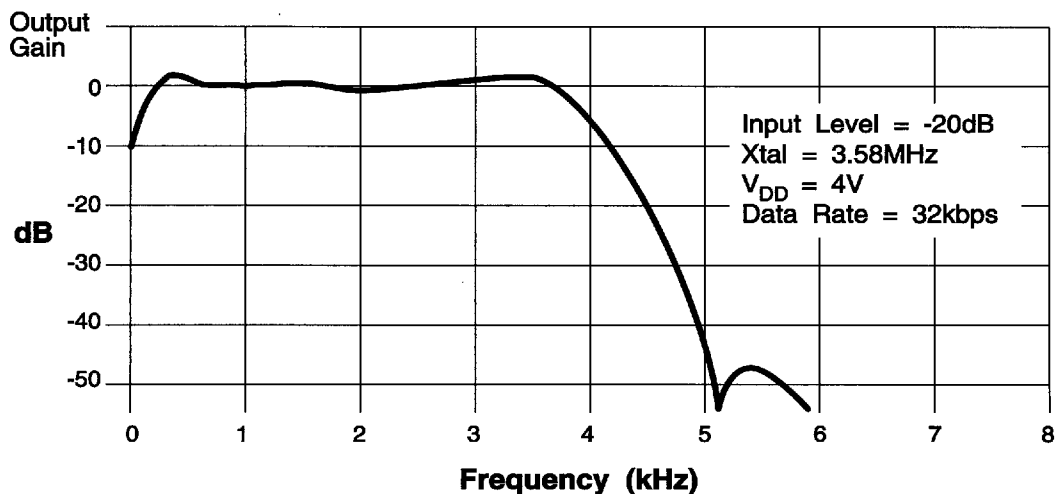


Figure 5 - Typical Codec Frequency Response

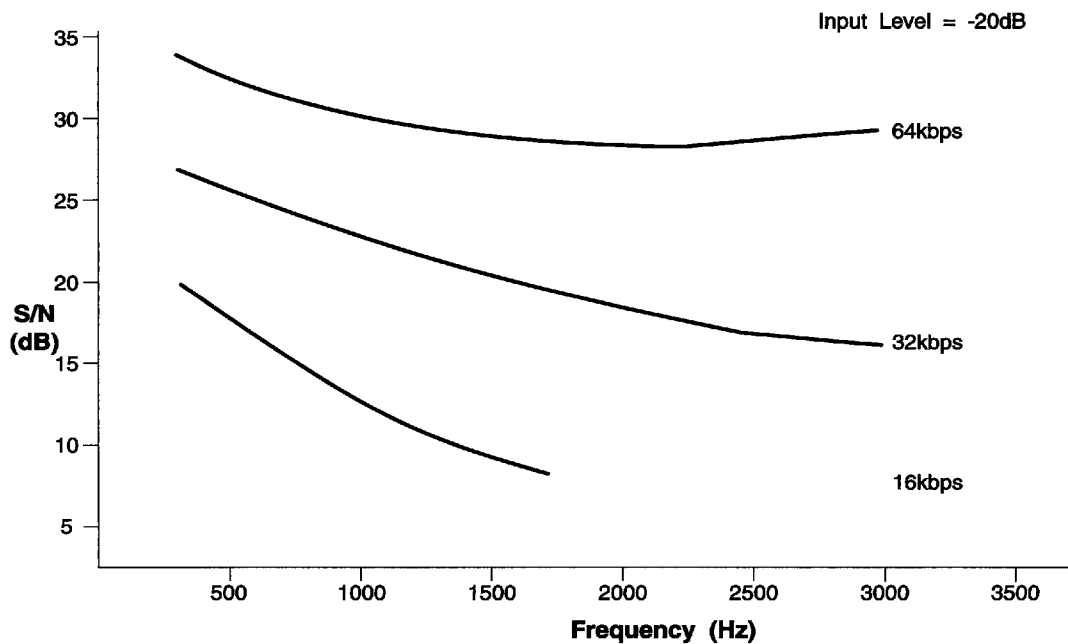


Figure 6 - Typical S/N Ratio with Input Frequency

SPECIFICATIONS

Absolute Maximum Ratings

Exceeding the maximum rating can result in device damage. Operation of the device outside the operating limits is not suggested.

Supply Voltage	-0.3 to 7.0V
Input Voltage at any pin (ref $V_{SS}=0V$)	-0.3 to ($V_{DD} + 0.3V$)
Sink/Source Current (Supply)	$\pm 30mA$
(Other Pins)	$\pm 20mA$
Total Device Dissipation (@ $T_{amb}=25^{\circ}C$)	800mW max.
Derating	10 mW/ $^{\circ}C$
Operating Temperature	$-30^{\circ}C$ to $+70^{\circ}C$
Storage Temperature	$-40^{\circ}C$ to $+85^{\circ}C$

Operating Limits

All devices were measured under the following conditions unless otherwise noted.

$$V_{DD} = 4.0V$$

$$\text{Audio Test Frequency} = 820Hz$$

$$T_{AMB} = 25^{\circ}C$$

$$\text{Sample Clock Rate} = 32 \text{ kbps}$$

$$\text{Xtal/Clock } f_0 = 3.58MHz$$

$$\text{Audio level } 0dB \text{ ref } (0 \text{ dBmO}) = 500mV_{rms}$$

Characteristics	See Note	Min.	Typ.	Max.	Unit
Static Values					
Supply Voltage	1	2.7	-	5.5	V
Supply Current		-	3.5	-	mA
Input Logic "1"		$70\%V_{DD}$	-	-	V
Input Logic "0"		-	-	$30\%V_{DD}$	V
Output Logic "1"		$80\%V_{DD}$	-	-	V
Output Logic "0"		-	-	$20\%V_{DD}$	V
Digital Input Impedance					
Logic I/O Pins		-	10	-	M Ω
Logic Input Pins, Pullup Resistor	2	300	-	-	k Ω
Digital Output Impedance		-	4	-	k Ω
Analog Input Impedance		-	100	-	k Ω
Analog Output Impedance	6	-	200	-	Ω
Insertion Loss	2	-	0	-	dB
Dynamic Values					
1					
Encoder:					
Analog Signal Input Levels	6	-30	-	+6	dB
Principal Integrator Frequency		-	275	-	Hz
Encoder Passband		-	3700	-	Hz
Comand Time Constant		-	4	-	ms
Decoder:					
Analog Signal Output Levels	6	-30	0	+6	dB
Decoder Passband	3	-	3700	-	Hz

Characteristics	See Note	Min.	Typ.	Max.	Unit
<u>Encoder/Decoder (Full Codec):</u>					
Passband		300	-	3400	Hz
Stopband		6	-	10	KHz
Stopband Attenuation		-	60	-	dB
Passband Gain		-	0	-	dB
Passband Ripple		-3	-	+3	dB
Output Noise (Input Short Circuit)		-	-60	-	dB
Group Delay Distortion	4				
(1000Hz-2600Hz)		-	-	450	μ s
(600Hz-2800Hz)		-	-	750	μ s
(500Hz-3000Hz)		-	-	1.5	ms
Xtal/Clock Frequency		3.0	3.58	4.0	MHz

NOTES:

1. Dynamic characteristics specified at 4V only.
2. All logic inputs except Encoder and Decoder Data Clocks.
3. With passband gain of ± 1 dB.
4. Group Delay Distortion for the full codec is relative to the delay with an 820Hz, -20dB signal at the encoder input.
5. Relative Timings are shown in Figure 4.
6. Recommended values.

